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ABSTRACT OF THE DISCLOSURE

10       The disclosure relates to a process for applying a multilayer protective coating to  
a substrate having an electrically conductive surface, comprising: (a) a first method of  
forming a silicate layer upon said electrically conductive surface, said first method  
comprising contacting at least a portion of said surface with a first medium comprising at  
least one silicate and having a basic pH and wherein said first medium is substantially  
free of chromates, to form a silicate layer, and (b) a second method of electrolytically  
15       applying a synthetic resin layer upon the surface of said silicate layer, said second  
method comprising contacting at least a portion of said surface of said silicate layer with  
a second medium comprising a resinous ingredient, applying an electric current to said  
second medium wherein said surface is employed as an electrode, to form a synthetic  
resin layer. The multilayer protective coating exhibits excellent corrosion and adhesion  
20       properties and is environmentally acceptable.